



# Status of the Tail Catcher/Muon Tracker

Presented by Victor Rykalin

for NICADD NIU

CALICE DECEMBER 7- 8 2004

# Outline

- **Current status.**
- **Plans.**

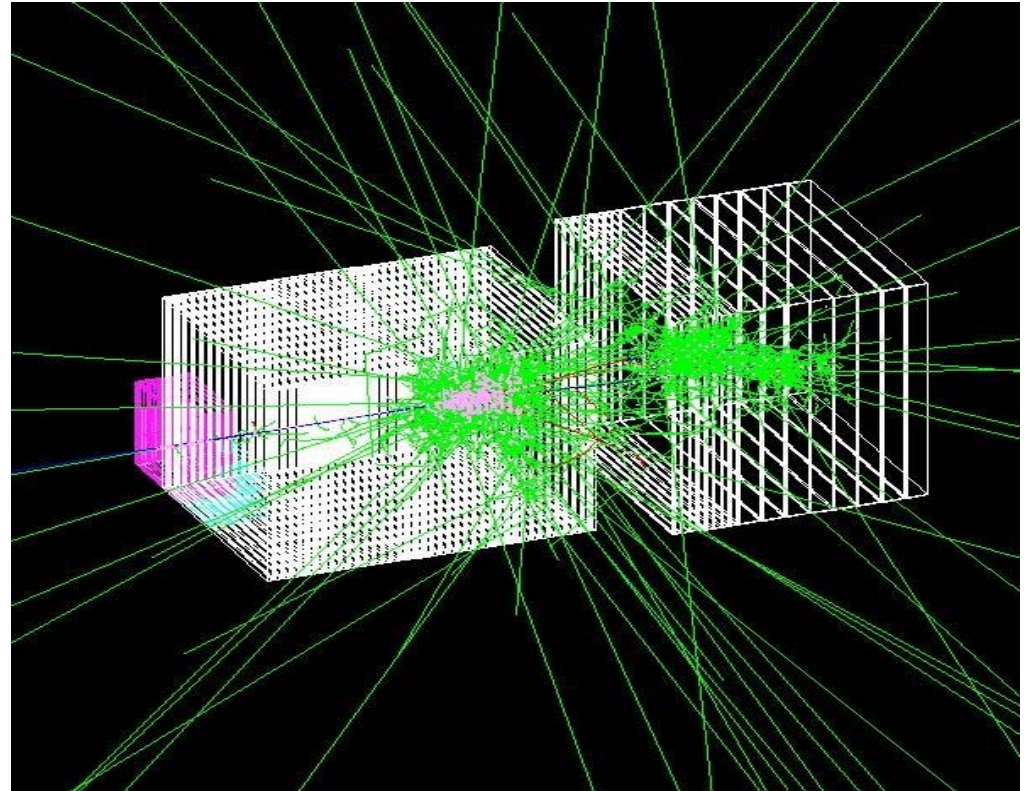
## Current status

- **Status of the TCMT**
  - a) **TCMT design** (TCMT for the test beam)
  - b) **Calibration and monitoring**
  - c) **Scintillator strips**
  - d) **Detectors (SiPM) and electronics**
  - e) **On-Site tests**

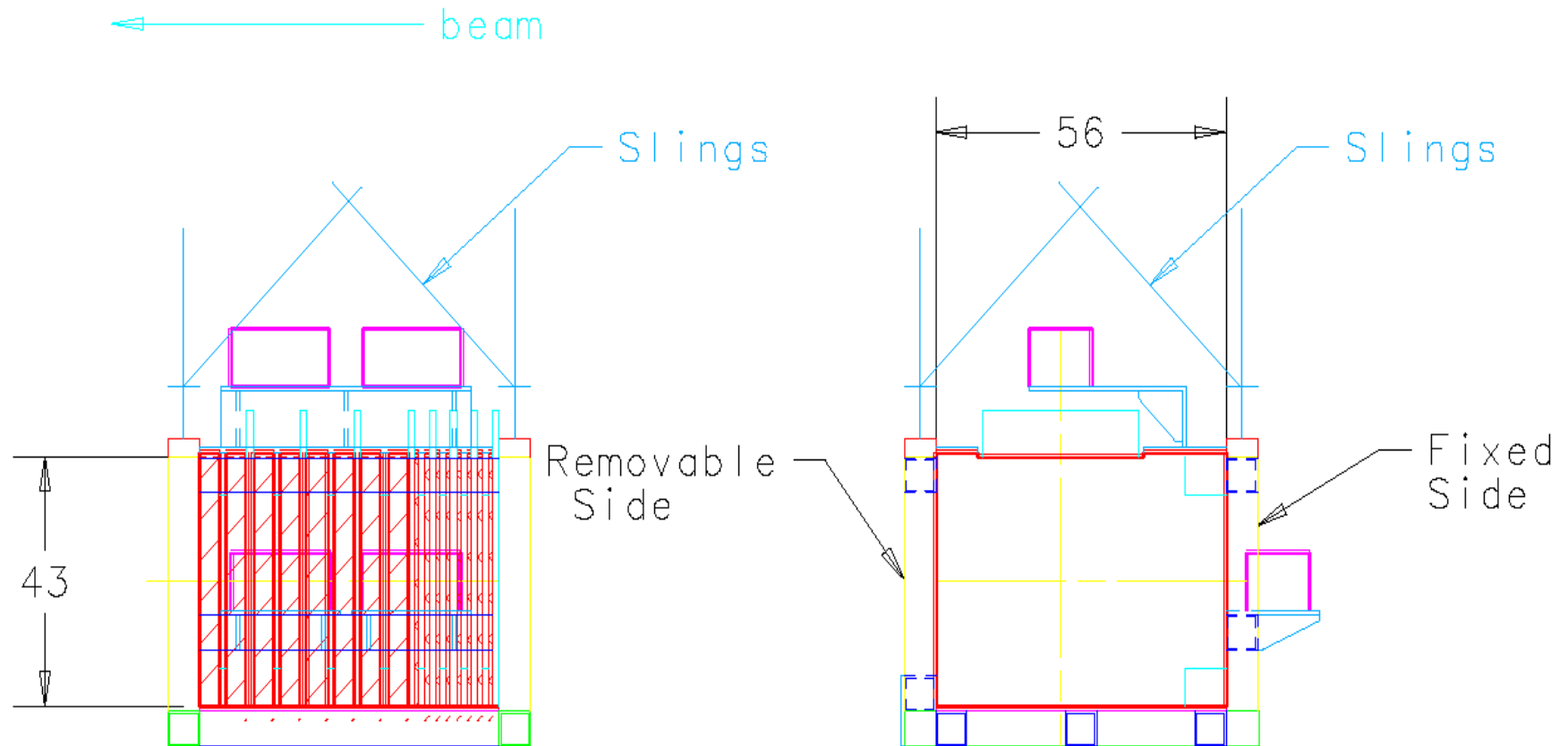
# TCMT design



- **Fine” section (8 layers)**  
**2 cm thick steel**
- **“Coarse” section (8 layers)**  
**10 cm thick steel**
- 5mm thick, 5cm wide strips
- Tyvek/VM2000 wrapping
- Alternating x-y orientation
- Si-PM photo detection
- Common readout with Hcal
- Along the beam - 142 cm
- Height - 109 cm
- Weight ~10 tons



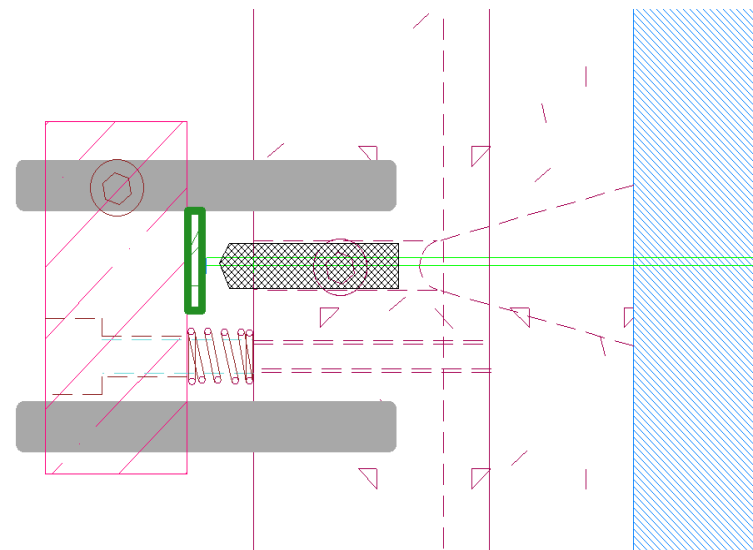
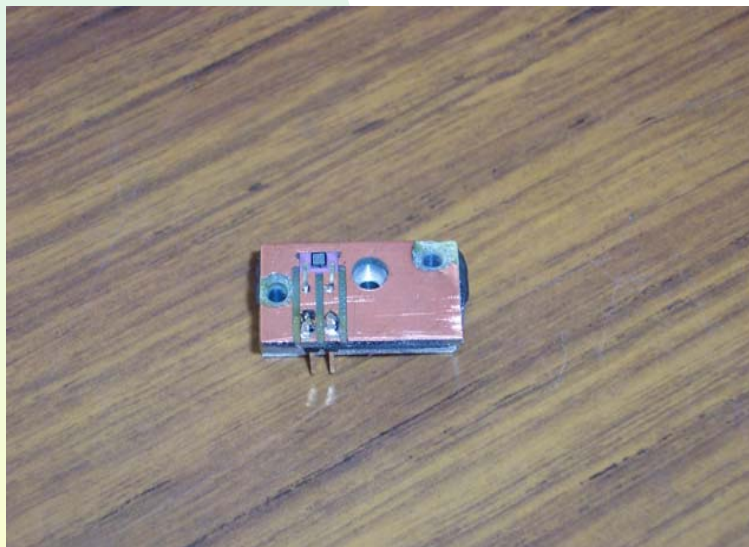
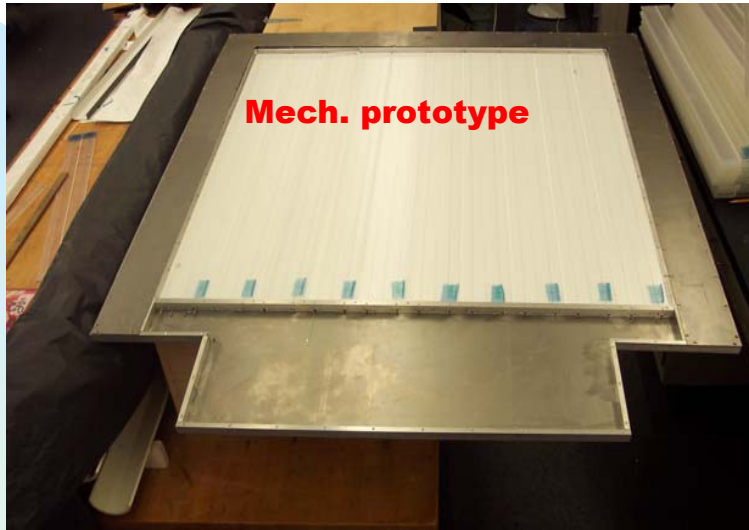
# Very preliminary mechanical support drawing.



Plotted by ingridf on 02-Dec-04 , File: NIULLCD.pff

- **Good quality steel plates from scrap is available (0.75 and 4 inches thick).**
- **Maximum size for the thicker plates is 1.066m x 1.2m.**
- **Cart being designed with about 10 ton load capacity.**
- **Will have the capability for forward-backward and left-right motion.**

# Tail Catcher one cassette view



12/14/2004



## Brief summary of the FNAL-NICADD extruded scintillator characteristics.

**Thickness:**  $\sigma \sim 0.6 \%$  (Over 300 m)

**Width :**  $\sigma \sim 0.2 \%$  (Over 300 m)

**LY non-uniformity**  $\sigma \sim 4 \%$  (across 10 cm)

**LY non-uniformity**  $\sigma \sim 2.2 \%$  (10\*10 cm<sup>2</sup>)

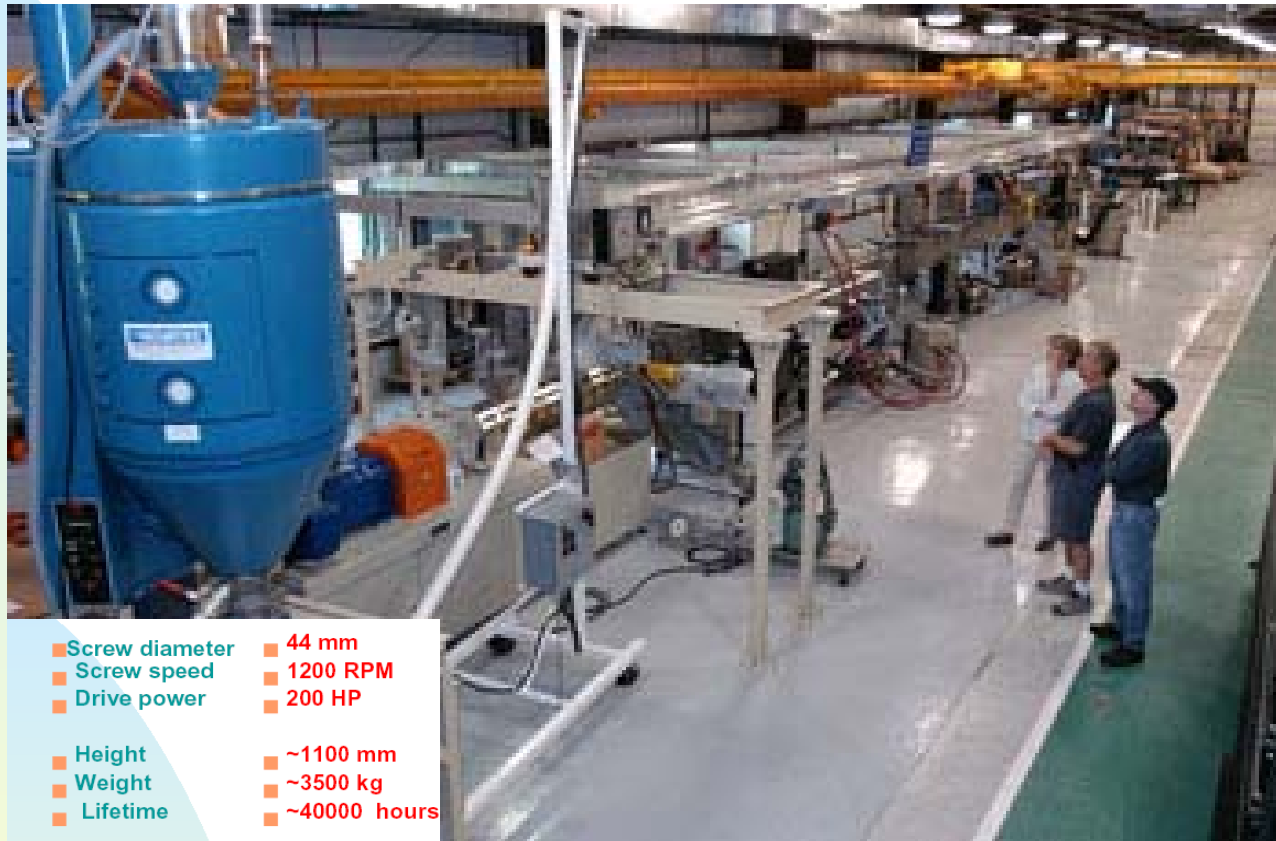
**LY non-uniformity**  $\sim 3 \%$  (Hexagonal cell 9 cm<sup>2</sup>)

**Light Yield** **66 % of BC408**

**$\sim 100\%$  of Kuraray SCSN-81**

**Rad. Hardness** **< 5 % LY degradation after 1 Mrad (gamma)**

# FNAL-NICADD extruder line



■ Screw diameter	■ 44 mm
■ Screw speed	■ 1200 RPM
■ Drive power	■ 200 HP
■ Height	■ ~1100 mm
■ Weight	■ ~3500 kg
■ Lifetime	■ ~40000 hours

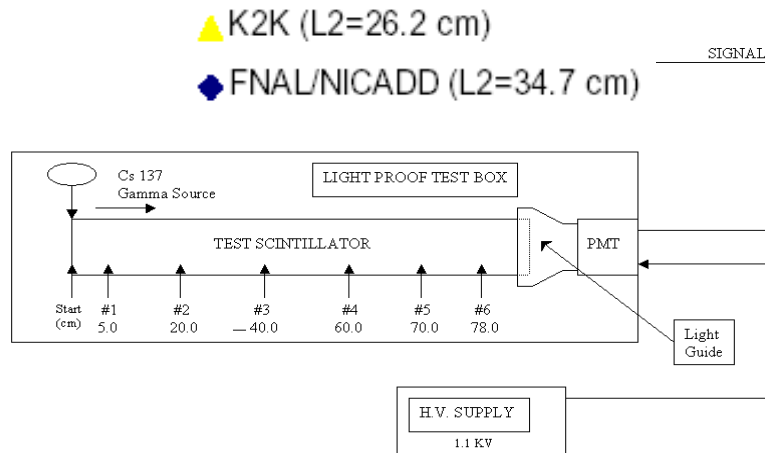
Output range

30-200kg/h

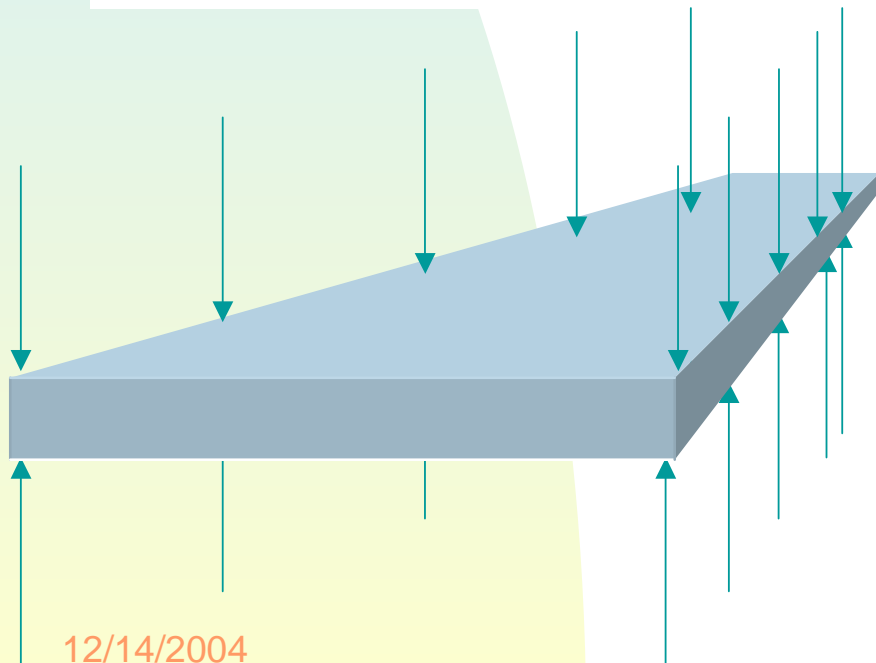


# QC on scintillator strips

## ATTENUATION LENGTH MEASUREMENT SETUP

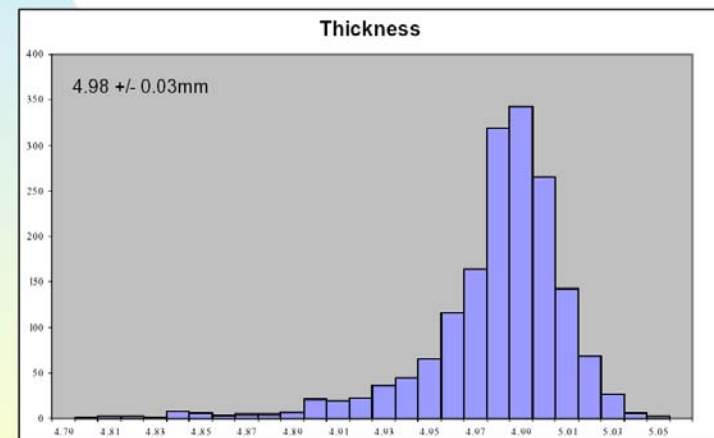


Number:	Batch:	L1 (Long)	L2 (Short)
1	1	41.3 cm	38.0 cm
101	6	59.9 cm	48.8 cm
121	7	69.0 cm	49.3 cm
161	9	64.1 cm	51.4 cm
182	10	31.3 cm	24.1 cm
Ref	-	43.7 cm	24.1 cm



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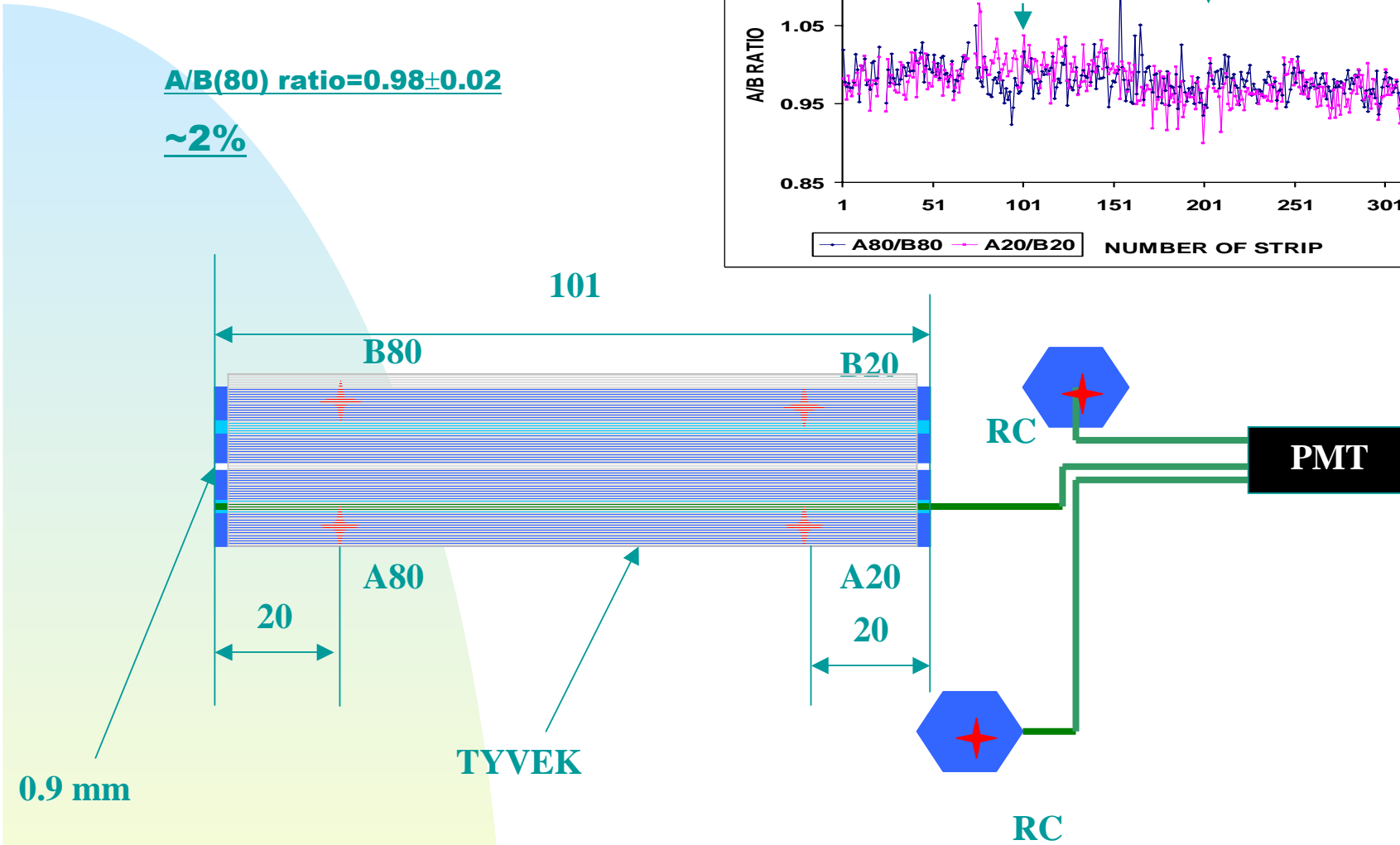
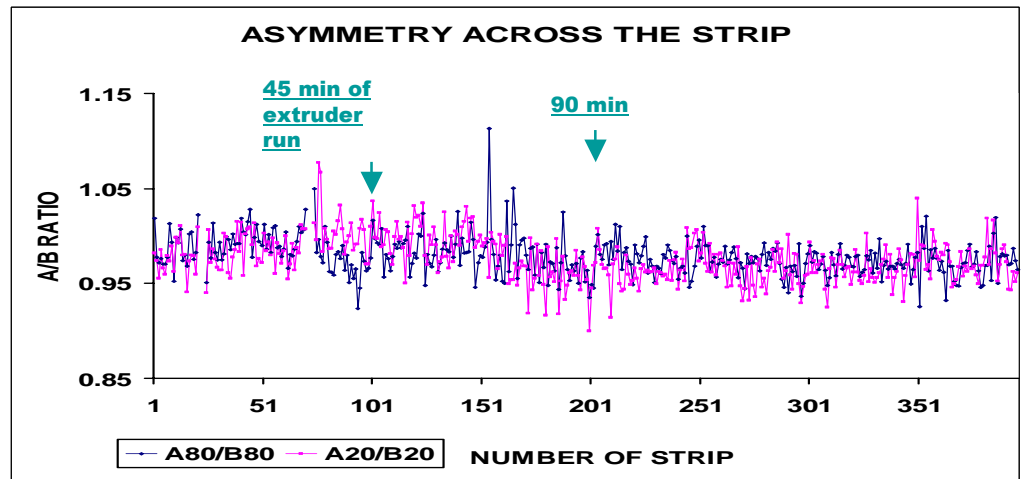
Thickness  $4.98 \pm 0.03$  mm



# QC on scintillator strips

A/B(80) ratio=0.98±0.02

~2%

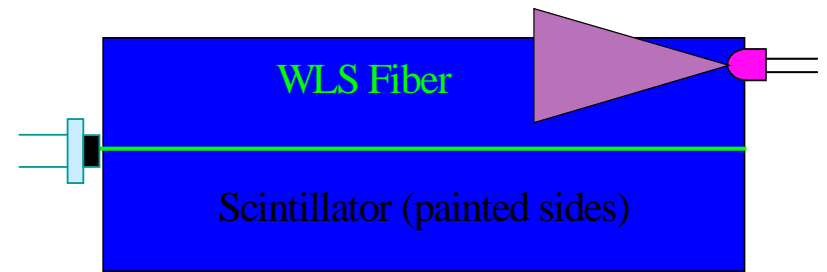


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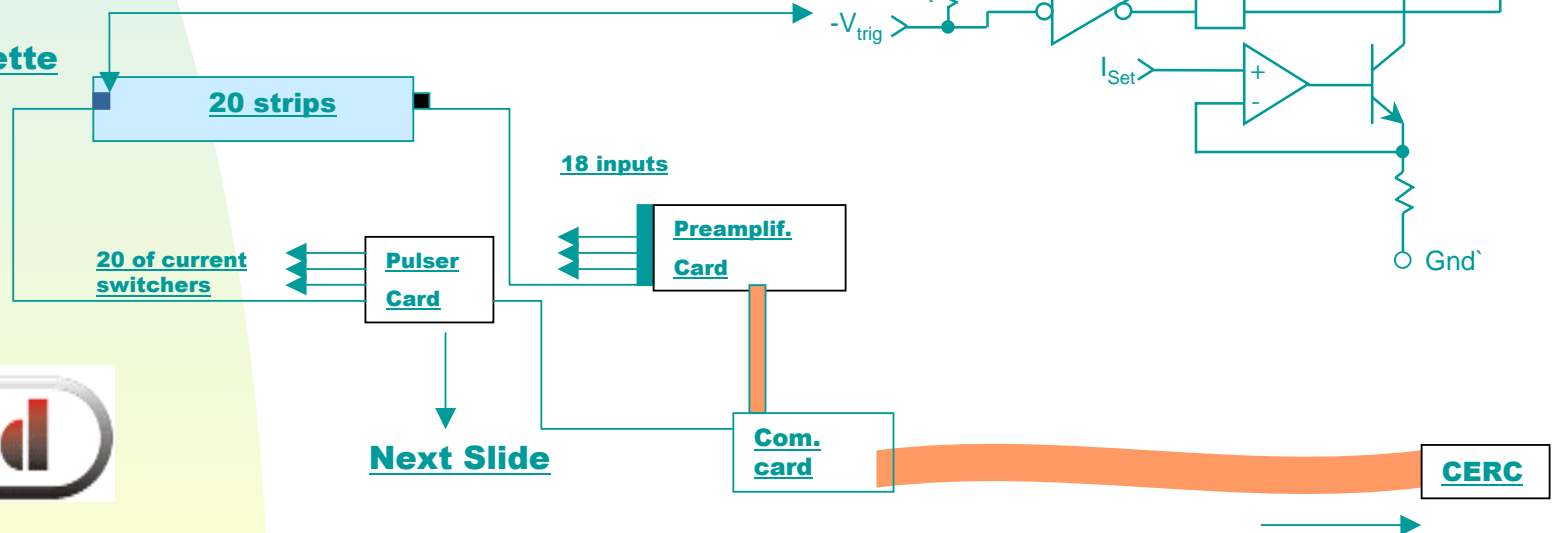
# Calibration and monitoring

- Individual LED driver for the each strip
- Preliminary driver design has been proposed
- Read-out schema is under discussion



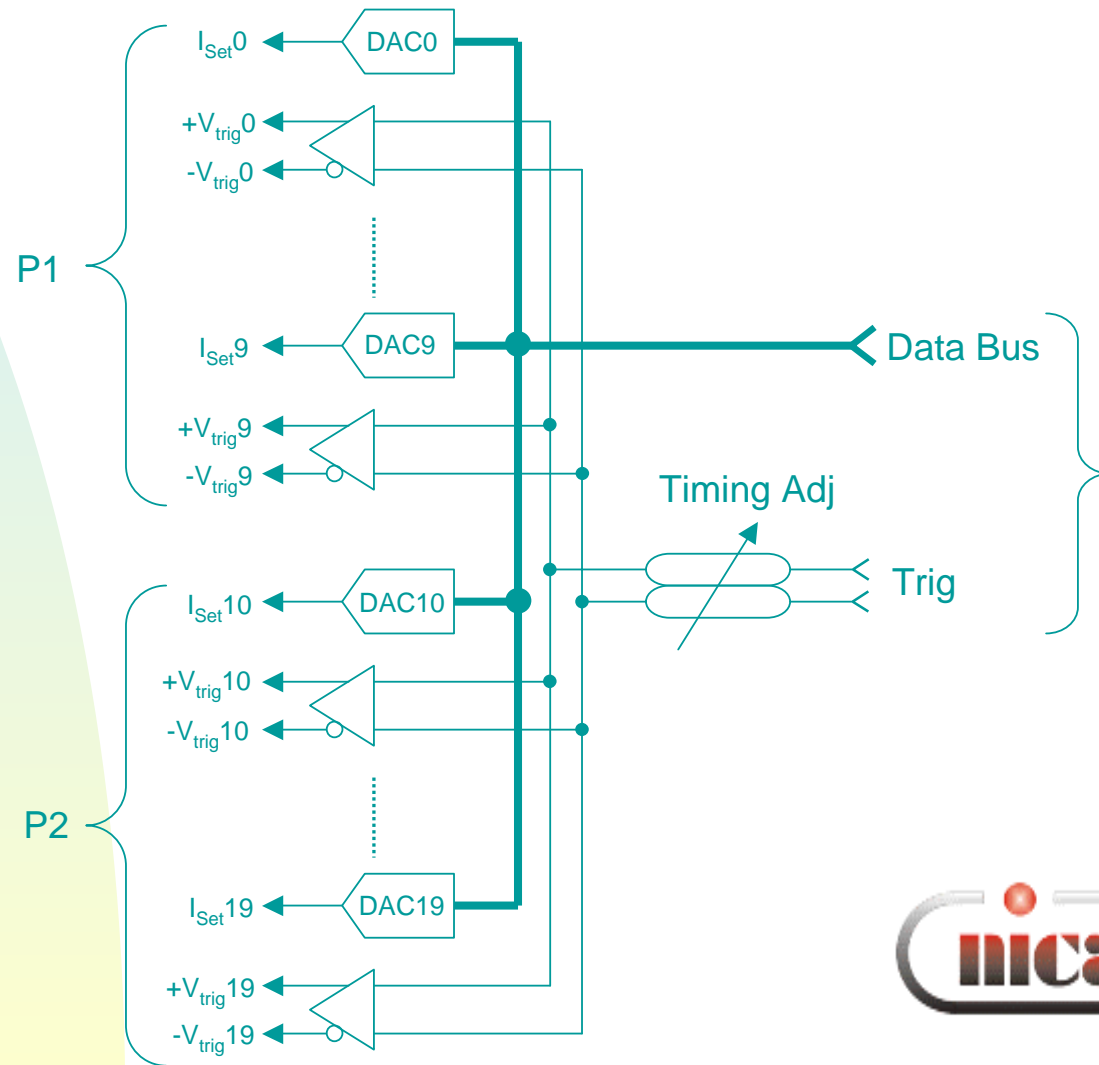
Block diagram of current switch at LED

One TCMT cassette includes



# Calibration(Proposed by Sten Hansen, FERMILAB)

Pulser Card Block Diagram

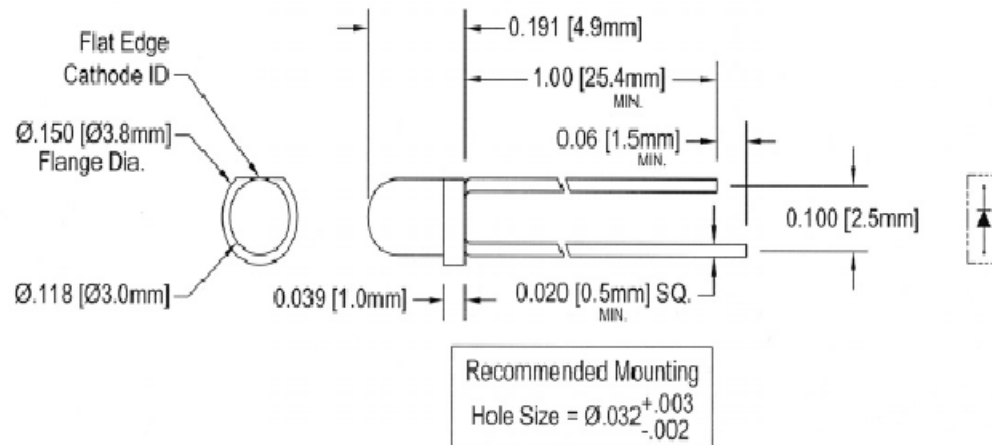
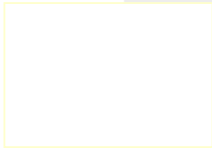


# LED information



## LED3-UV-XXX-30 Series 3mm Ultraviolet LED

LED Part No.	Chip			Lens Appearance	Absolute Max. Ratings				Electro-Optical Data @20mA			Viewing Angle 2 θ 1/2 (deg)
	Material	Peak Wave Length λp(nm)	Emitted Color		Δ λ (nm)	Pd (mW)	If (mA)	Peak If (mA)	Vf (V)		Iv (mcd)	
									TYP	MAX	TYP	
LED3-UV-395-30	InGaN	395	BLUE UV	WATER CLEAR	60	100	30	100	3.7	4.0	11.0	30
LED3-UV-400-30	InGaN	400	BLUE UV	WATER CLEAR	60	100	30	100	3.7	4.0	12.0	30
LED3-UV-405-30	InGaN	405	BLUE UV	WATER CLEAR	60	100	30	100	3.7	4.0	12.0	30

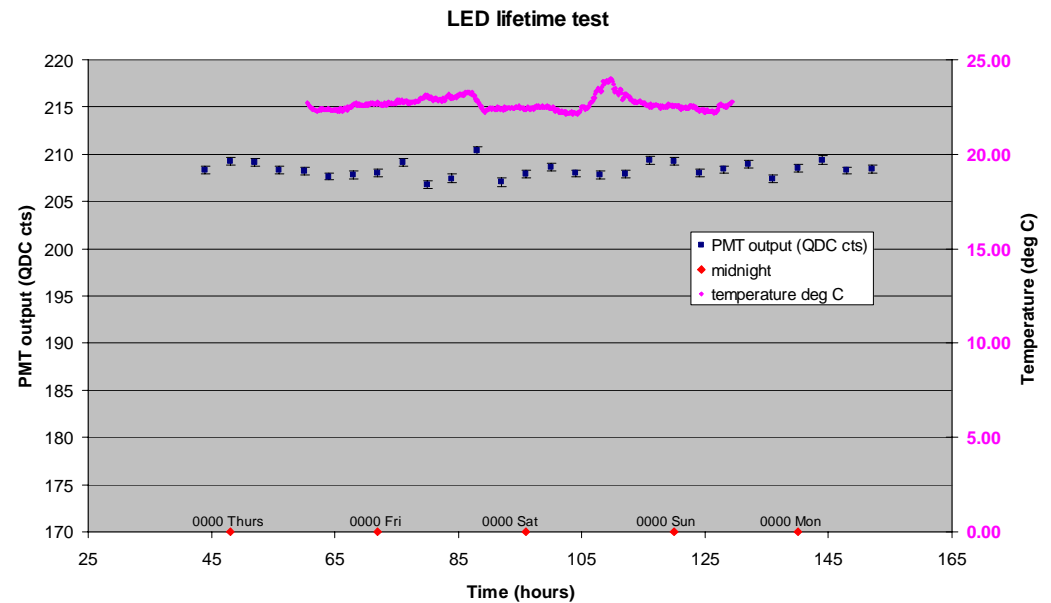
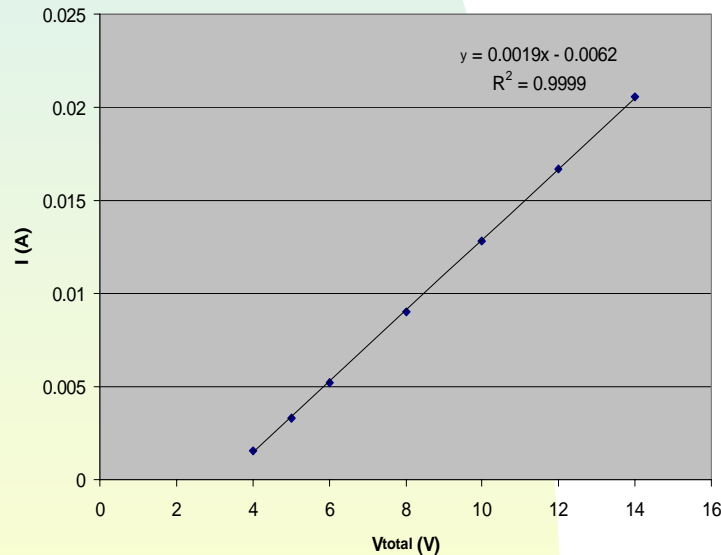




# UV LED R&D

- All LEDs show good reproducibility in the characteristic behavior**
- ~\$1 UV LED is a promising candidate for the calibration of each scintillator strip+SiPM.**
- R&D is under way**

	LED 1	LED 2	LED 3	LED 4	LED 5	LED 6	LED 7	LED 8	LED 9	LED 10
<b>4.14V</b>										
slope	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019
intercept	0.0062	0.0062	0.0061	0.0062	0.0062	0.0062	0.0062	0.0062	0.0062	0.0063
R <sup>2</sup>	0.9999	0.9999	0.9999	0.9999	0.9999	0.9999	0.9999	0.9999	0.9999	0.9999
<b>5-14V</b>										
slope	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019	0.0019
intercept	0.0063	0.0063	0.0062	0.0063	0.0063	0.0063	0.0063	0.0063	0.0063	0.0064
R <sup>2</sup>	1	1	1	1	1	1	0.9999	0.9999	1	1



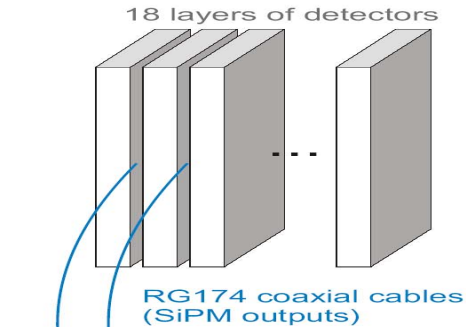
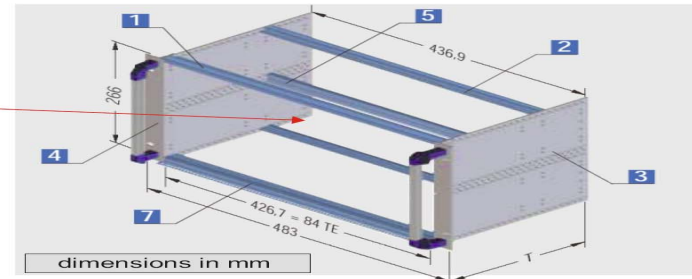
## Detectors and electronics

- **Layout of electronics**
- **New setup for the SiPM commissioning was prepared**
- **Encapsulation test of the SiPM bonds was performed**
- **The measurements before and after encapsulation were carried out**

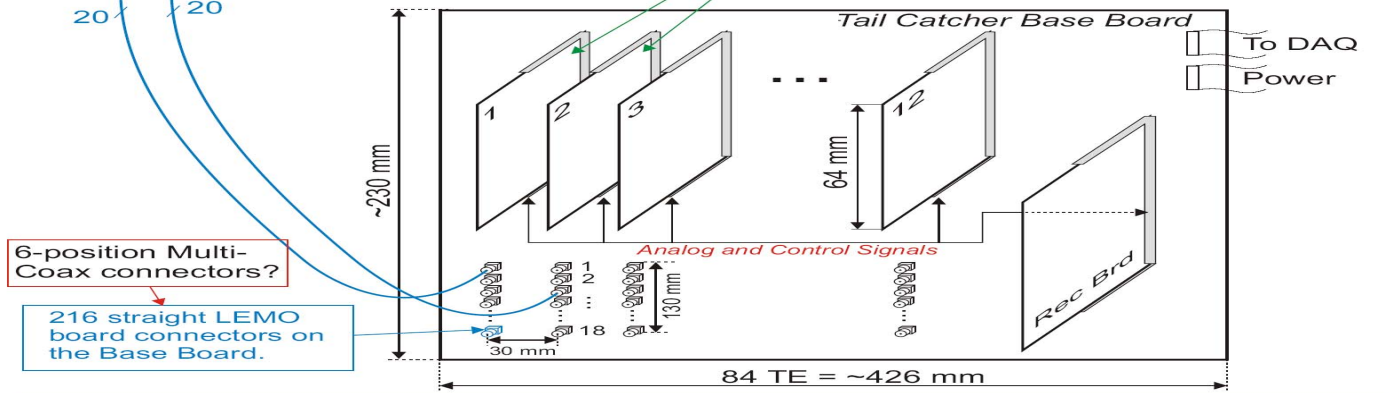
# Layout of electronics

Tail Catcher Base Board is placed in a standard 19" Crate (Backplane).  
**2 Crates are needed for the analog channels**

**$16 * 20 = 320$**



12 Analog Boards with one ASIC (=18 channels) on one Base Board.  
 Analog Boards are stacked vertically onto the Base Board with a pitch of ~3cm.  
 Dimensions :  
 Analog Board : 9 x 6.4 cm<sup>2</sup>  
 Rec Board : 10 x 7.7 cm<sup>2</sup>



6-position Multi-Coax connectors?

216 straight LEMO board connectors on the Base Board.

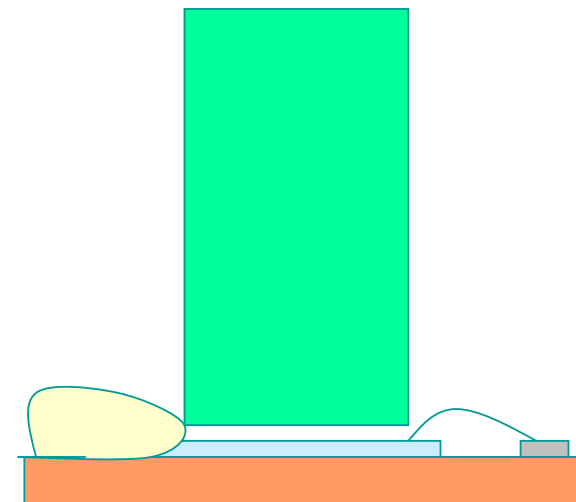
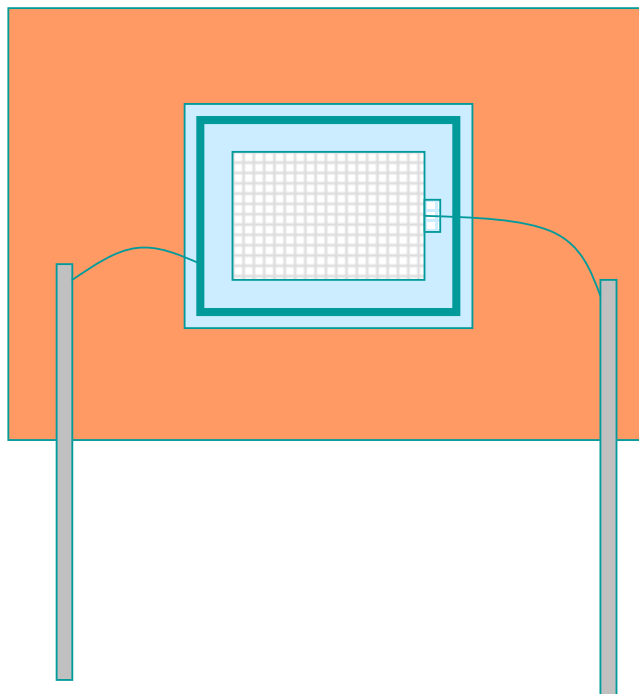


# Encapsulation of the wire bonds

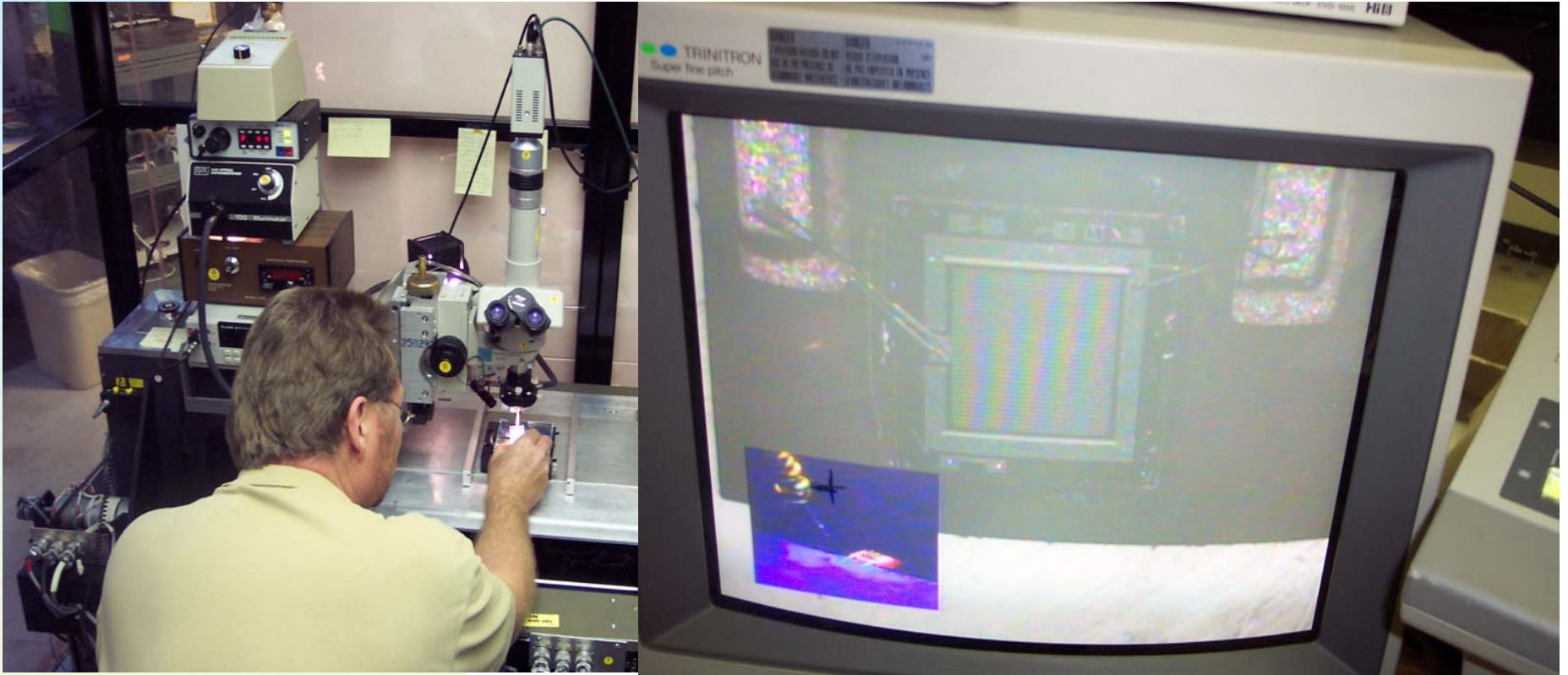
\* Easy to damage

\* Experience of the D0  
SiMT

\* Availability of the  
equipment at FNAL Si Det.  
lab.

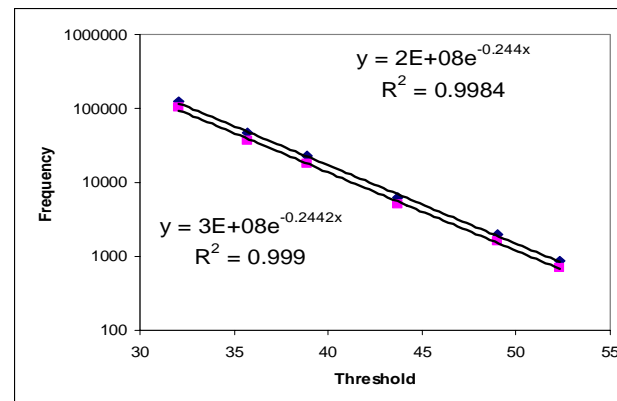
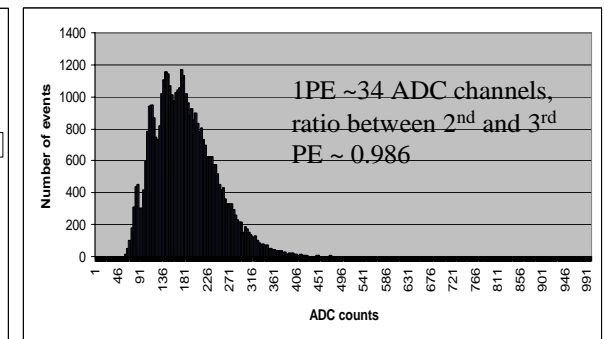
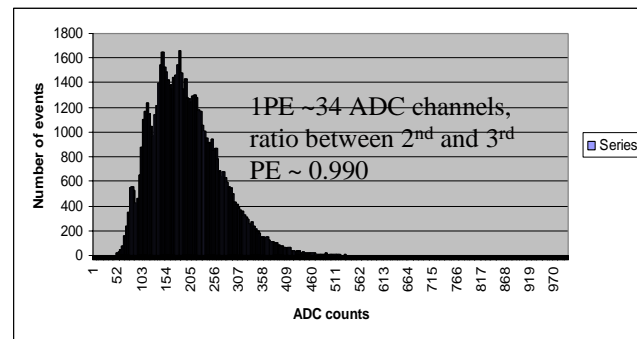
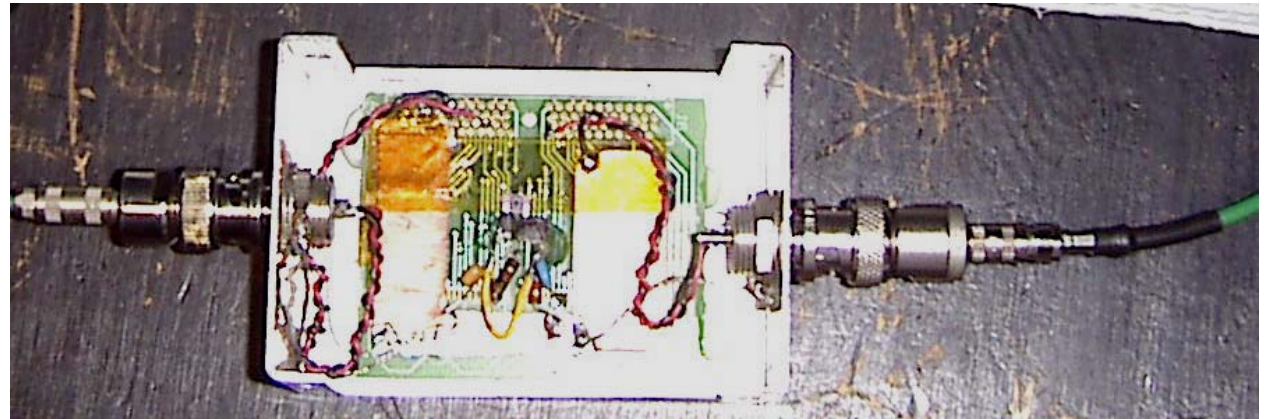


## Encapsulation setup



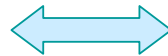
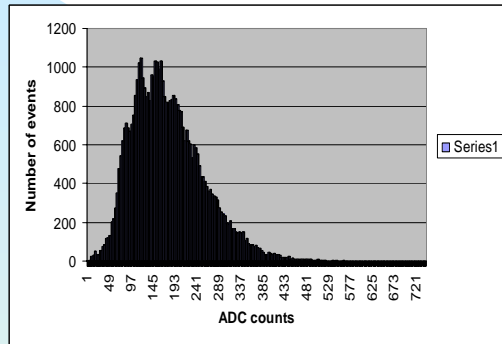
# New setup and tests results .

1. Allows to have reproducible light flux during the tests
2. Meets mechanical problems(bent legs, different distance between them)
3. Simple and robust
4. We are going to evaluate each sensor (working point)

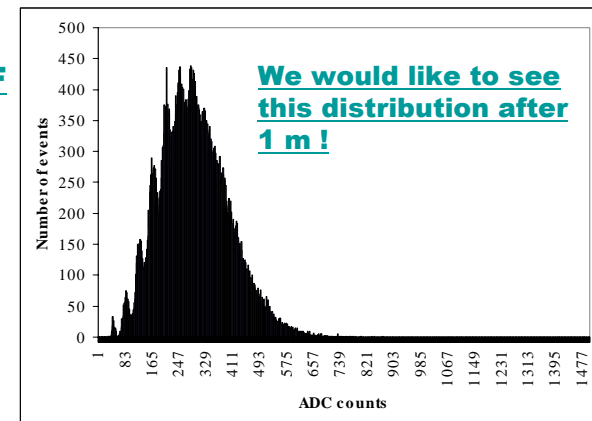
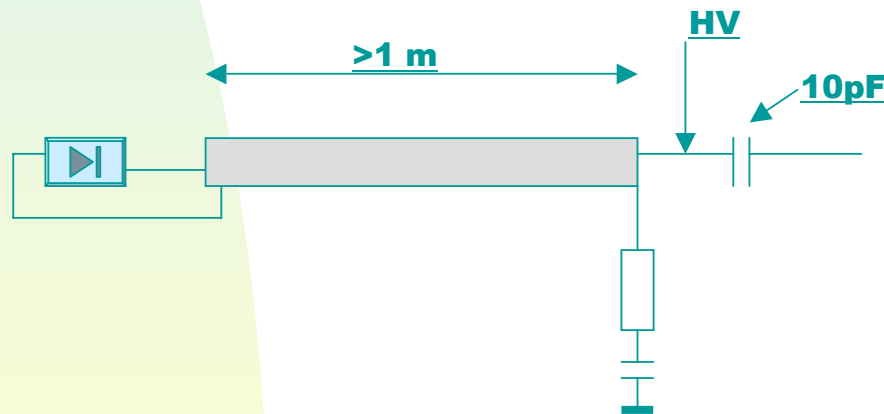


Data was taken: before at 25.3C,  
after at 24.9C, thus small difference  
in absolute value of counts, but the  
slope is the same and the behavior or  
noise is the same

# On-Site test and results



- Different lengths of the cable were tested.
- Currently we are comfortable with length of 30 cm with electronics we have.
- The real electronics(FLC\_PHY3) tests are necessary with longer cables.
- Some assistance from electronics experts will be requested during current visit to DESY.



# Plans

- **LED calibration system:** to test a single prototype of the current driver.
- **LED:** to perform a long time stability tests with temperature tracking.
- **Electronics:** To perform a test with real electronics for one cassette prototype. We expect to test one board at NICADD.
- **SiPM sensors:** to find a working point for each sensor.
- **Mechanics:** To make an over all design.



# Schedule

**Strips : Done**

**SiPM : 25 ok!, will need more starting Feb.**

**Cassette: Mech. Prototype done, 1st ready  
Feb.05**

**LED System: design ready this year, prototype  
ready in Jan. 05**

**Stack & Cart:Construction starts Feb. 05**